PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT7391613

| SUBMISSION TYPE: | NEW ASSIGNMENT |
|-----------------------|----------------|
| NATURE OF CONVEYANCE: | ASSIGNMENT |

CONVEYING PARTY DATA

| Name | Execution Date |
|--------------|----------------|
| Ming-Fu Tsai | 05/17/2022 |

RECEIVING PARTY DATA

| Name: | Elite Semiconductor Microelectronics Technology Inc. |
|-----------------|--|
| Street Address: | No 23, Industry E. Road IV, Hsinchu Science Park |
| City: | Hsinchu |
| State/Country: | TAIWAN |

PROPERTY NUMBERS Total: 1

| Property Type | Number |
|---------------------|----------|
| Application Number: | 17844692 |

CORRESPONDENCE DATA

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| ATTORNEY DOCKET NUMBER: | ESMP0141USA |
|-------------------------|-------------|
| NAME OF SUBMITTER: | SIBYL YU |
| SIGNATURE: | /SIBYL YU/ |
| DATE SIGNED: | 06/20/2022 |

Total Attachments: 2 source=4601465#page1.tif source=4601465#page2.tif

PATENT 507344691 REEL: 060253 FRAME: 0490

COMBINE DECLARATION (37 CFR 1.63) FOR UTILITY OR DESIGN APPLICATION USING AN APPLICATION DATA SHEET (37 CFR 1.76) AND ASSIGNMENT

Title of Invention:

METHOD FOR INCREASING RESOLUTION BY N BITS PERFORMED BY PROCESSING CIRCUIT OF MOTOR DRIVING SYSTEM AND ASSOCIATED MOTOR DRIVING SYSTEM

| As the below named inventor, I hereby declare that: This declaration is directed to: | | | |
|---|---|--|-----------|
| ☑ The attached application, or | | | |
| ☐ United States application number | | filed on | _, or |
| ☐ PCT international application number | | filed on | |
| The above-identified application was | s made or authorized to be made | by me. | |
| I believe that I am the original inventor or an original joint inventor of a claimed invention in the application. | | | |
| I hereby acknowledge that any willful false statement made in this declaration is punishable under18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both. | | | |
| In consideration of the payment by | Elite Semiconductor Microelectronics Technol | having a postal adogy Inc. | ldress of |
| No 23, Industry E. Road IV, H | sinchu Science Park, Hsin | chu 30077, Taiwan, R.O | .C. |
| (referred to as "ASSIGNEE"below) to acknowledged, andfor other good ar | o I of the sum of One Dollar (\$ 1. id valuable consideration. | .00), the receipt of which is h | ereby |
| I hereby sell, assign and transfer to ASSIGNEE and the successors and assignees of the ASSIGNEE the entire right, title and interest in and to any and all improvements which are disclosed in the invention as above-identified application and, in and to, all Letters Patent to be obtained for said invention by the above application or any continuations, continuation-in-part, divisions, renewals, substitutes, or extensions thereof, and as to Letters Patent any reissue or re-examination thereof. | | | |
| I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment; | | | |
| I further covenant that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said invention and said Letters Patent and legal equivalents as may be known and accessible to I and will testify as to the same in any interference, litigation proceeding related thereto and will promptly execute and deliver to ASSIGNEE or its legal | | | |
| representatives any and all papers, instruments or affidavits required to apply for, obtain, maintain, issue and enforce said application, said invention and said Letters Patent and said equivalents thereof which may be necessary or desirable to carry out the proposes thereof. IN WITNESS WHEREOF, I have hereunto set hand and seal this on the date(s) indicated. | | | |
| Note: An application data sheet (PTC inventive entity, must accompany this | D/SB/14 or equivalent), including s form. Use this form for <u>each ac</u> | naming the entire Iditional inventor. | |

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F#NPO-P0002E-US1201 DSB0-111U014317

Docket No ESMP0141USA

| LEGAL NAME OF INVENTOR(ASSIGNOR) | | | | |
|----------------------------------|-----------------|-------|-------------|--|
| Inventor: | Ming-Fu Tsai | Date: | 2022, 5, 17 | |
| Signature: | Ming - Fry Tsai | | | |
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F#NPO-P0002E-US1201 DSB0-111U014317

NPO#ESM-P0141-USA:0 CUST#ES22003

RECORDED: 06/20/2022

PATENT REEL: 060253 FRAME: 0492